

Product Specification

(Preliminary)

Part Name: OEL Display Module

Part ID: UG-2828GDEDF11

Doc No.: SAS1-D038-A

Customer:
Approved by

CONFIDENTIAL

From: Univision Technology Inc.
Approved by

Univision Technology Inc.

8, Kebei RD 2, Science Park, Chu-Nan, Taiwan 350, R.O.C.

Notes:

1. Please contact Univision Technology Inc. before assigning your product based on this module specification
2. The information contained herein is presented merely to indicate the characteristics and performance of our products. No responsibility is assumed by Univision Technology Inc. for any intellectual property claims or other problems that may result from application based on the module described herein.

Revised History

Part Number	Revision	Revision Content	Revised on
UG-2828GDEDF11	A	New	October 15, 2008
CONFIDENTIAL			

CONFIDENTIAL

Notice:

No part of this material may be reproduced or duplicated in any form or by any means without the written permission of Univision Technology Inc. Univision Technology Inc. reserves the right to make changes to this material without notice. Univision Technology Inc. does not assume any liability of any kind arising out of any inaccuracies contained in this material or due to its application or use in any product or circuit and, further, there is no representation that this material is applicable to products requiring high level reliability, such as, medical products. Moreover, no license to any intellectual property rights is granted by implication or otherwise, and there is no representation or warranty that anything made in accordance with this material will be free from any patent or copyright infringement of a third party. This material or portions thereof may contain technology or the subject relating to strategic products under the control of Foreign Exchange and Foreign Trade Law of Taiwan and may require an export license from the Ministry of International Trade and Industry or other approval from another government agency.

© Univision Technology Inc. 2008, All rights reserved.

All other product names mentioned herein are trademarks and/or registered trademarks of their respective companies.

Contents

Revision History	<i>i</i>
Notice	<i>ii</i>
Contents	<i>iii</i>
1. Basic Specifications	<i>1~6</i>
1.1 Display Specifications	1
1.2 Mechanical Specifications	1
1.3 Active Area & Pixel Construction	1
1.4 Mechanical Drawing	2
1.5 Pin Definition	3
1.6 Block Diagram	6
2. Absolute Maximum Ratings	<i>7</i>
3. Optics & Electrical Characteristics	<i>8~12</i>
3.1 Optics Characteristics	8
3.2 DC Characteristics	8
3.3 AC Characteristics	9
3.3.1 68XX-Series MPU Parallel Interface Timing Characteristics	9
3.3.2 80XX-Series MPU Parallel Interface Timing Characteristics	10
3.3.3 Serial Interface Timing Characteristics (4-wire SPI)	11
3.3.4 Serial Interface Timing Characteristics (3-wire SPI)	12
4. Functional Specification	<i>13~14</i>
4.1 Commands	13
4.2 Power down and Power up Sequence	13
4.2.1 Power up Sequence	13
4.2.2 Power down Sequence	13
4.3 Reset Circuit	13
4.4 Actual Application Example	14
5. Reliability	<i>15</i>
5.1 Contents of Reliability Tests	15
5.2 Lifetime	15
5.3 Failure Check Standard	15
6. Outgoing Quality Control Specifications	<i>16~20</i>
6.1 Environment Required	16
6.2 Sampling Plan	16
6.3 Criteria & Acceptable Quality Level	16
6.3.1 Cosmetic Check (Display Off) in Non-Active Area	16
6.3.2 Cosmetic Check (Display Off) in Active Area	19
6.3.3 Pattern Check (Display On) in Active Area	20
7. Package Specifications	<i>21</i>

8. Precautions When Using These OEL Display Modules..... 22~24

- 8.1 Handling Precautions22
- 8.2 Storage Precautions.....23
- 8.3 Designing Precautions23
- 8.4 Precautions when disposing of the OEL display modules.....24
- 8.5 Other Precautions.....24

CONFIDENTIAL

1. Basic Specifications

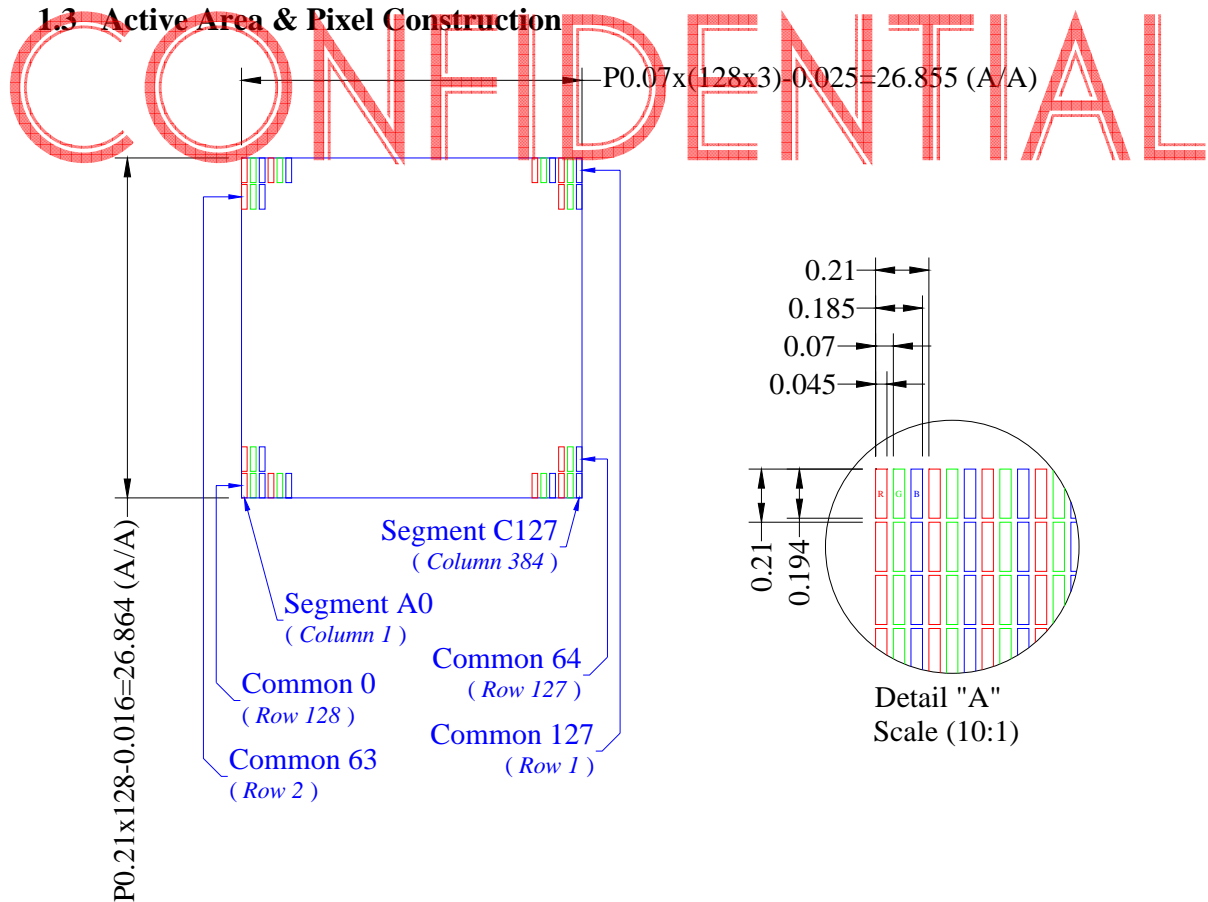
1.1 Display Specifications

- 1) Display Mode: Passive Matrix
- 2) Display Color: 262,144 Colors (Maximum)
- 3) Drive Duty: 1/128 Duty

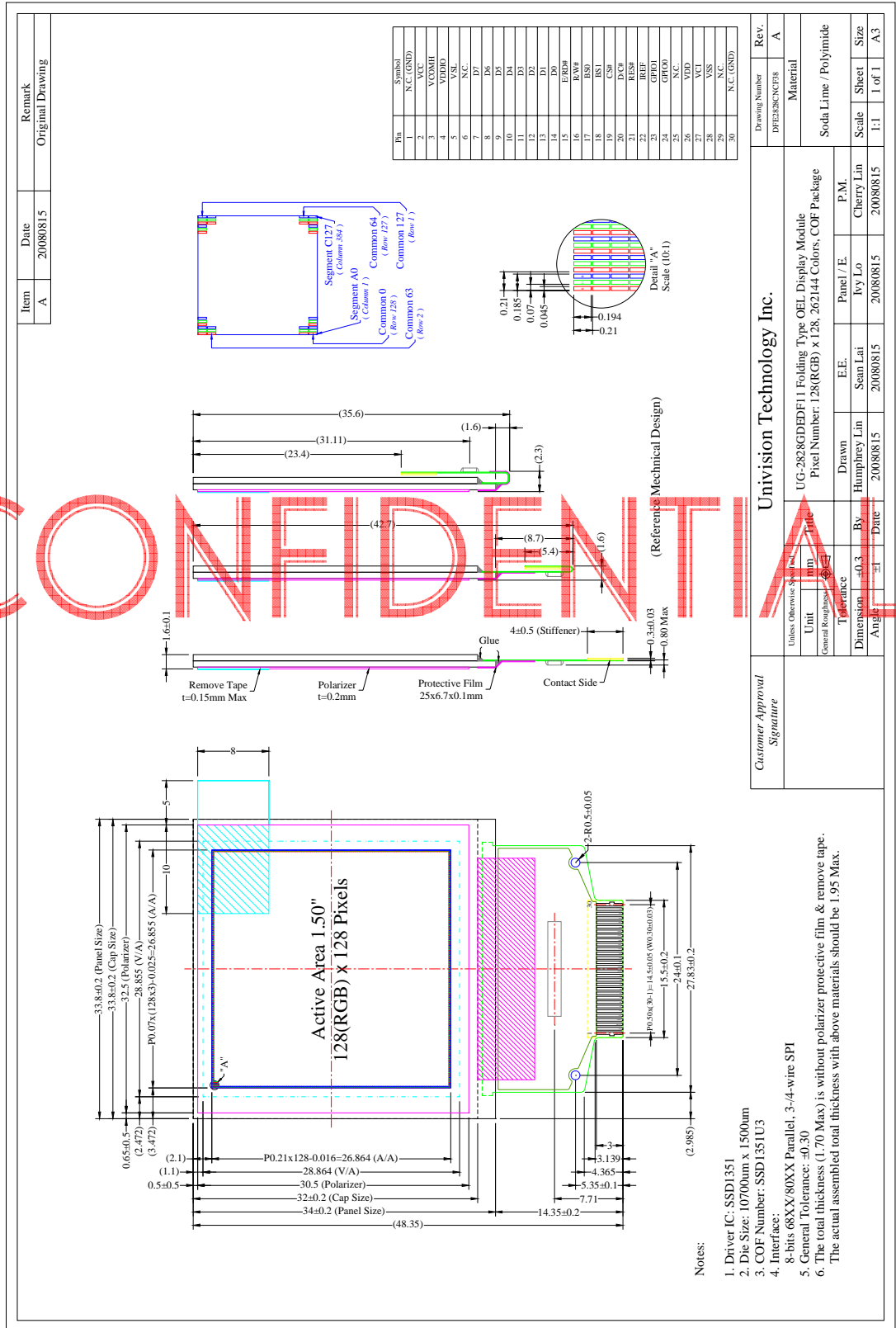
1.2 Mechanical Specifications

- 1) Outline Drawing: According to the annexed outline drawing
- 2) Number of Pixels: 128 (RGB) × 128
- 3) Panel Size: 33.80 × 34.00 × 1.60 (mm)
- 4) Active Area: 26.855 × 26.864 (mm)
- 5) Pixel Pitch: 0.07 × 0.21 (mm)
- 6) Pixel Size: 0.045 × 0.194 (mm)
- 7) Weight: 3.75 (g)

1.3 Active Area & Pixel Construction



1.4 Mechanical Drawing



The drawing contained herein is the exclusive property of Univision. It is not allowed to copy, reproduce and/or disclose in any format without permission of Univision.

1.5 Pin Definition

Pin Number	Symbol	Type	Function
Power Supply			
27	VCI	P	Power Supply for Operation This is a voltage supply pin. It must be connected to external source & always be equal to or higher than VDD & VDDIO.
26	VDD	P	Power Supply for Core Logic Circuit This is a voltage supply pin which is regulated internally from VCI. A capacitor should be connected between this pin & VSS under all circumstances.
4	VDDIO	P	Power Supply for I/O Pin This pin is a power supply pin of I/O buffer. It should be connected to VCI or external source. All I/O signal should have VIH reference to VDDIO. When I/O signal pins (BS0~BS1, D0~D7, control signals...) pull high, they should be connected to VDDIO.
28	VSS	P	Ground of OEL System This is a ground pin. It also acts as a reference for the logic pins, the OEL driving voltages, and the analog circuits. It must be connected to external ground.
2	VCC	P	Power Supply for OEL Panel This is the most positive voltage supply pin of the chip. It must be connected to external source.
Driver			
22	IREF	I	Current Reference for Brightness Adjustment This pin is segment current reference pin. A resistor should be connected between this pin and VSS. Set the current lower than 12.5uA.
3	VCOMH	P	Voltage Output High Level for COM Signal This pin is the input pin for the voltage output high level for COM signals. A tantalum capacitor should be connected between this pin and VSS.
5	VSL	P	Voltage Output Low Level for SEG Signal This is segment voltage reference pin. When external VSL is not used, this pin should be left open. When external VSL is used, this pin should connect with resistor and diode to ground.
External IC Control			
24 23	GPIO0 GPIO1	I/O	General Purpose Input/Output These pins could be left open individually or have signal inputted/outputted. They are able to use as the external DC/DC converter circuit enabled/disabled control or other applications.

CONFIDENTIAL

1.5 Pin Definition (Continued)

Pin Number	Symbol	I/O	Function															
<i>Interface</i>																		
17 18	BS0 BS1	I	<p>Communicating Protocol Select These pins are MCU interface selection input. See the following table:</p> <table border="1"> <thead> <tr> <th></th> <th>BS0</th> <th>BS1</th> </tr> </thead> <tbody> <tr> <td>3-wire SPI</td> <td>1</td> <td>0</td> </tr> <tr> <td>4-wire SPI</td> <td>0</td> <td>0</td> </tr> <tr> <td>68XX-parallel (8-bit)</td> <td>1</td> <td>1</td> </tr> <tr> <td>80XX-parallel (8-bit)</td> <td>0</td> <td>1</td> </tr> </tbody> </table>		BS0	BS1	3-wire SPI	1	0	4-wire SPI	0	0	68XX-parallel (8-bit)	1	1	80XX-parallel (8-bit)	0	1
	BS0	BS1																
3-wire SPI	1	0																
4-wire SPI	0	0																
68XX-parallel (8-bit)	1	1																
80XX-parallel (8-bit)	0	1																
21	RES#	I	<p>Power Reset for Controller and Driver This pin is reset signal input. When the pin is low, initialization of the chip is executed.</p>															
19	CS#	I	<p>Chip Select This pin is the chip select input. The chip is enabled for MCU communication only when CS# is pulled low.</p>															
20	D/C#	I	<p>Data/Command Control This pin is Data/Command control pin. When the pin is pulled high, the input at D7~D0 is treated as display data. When the pin is pulled low, the input at D7~D0 will be transferred to the command register. For detail relationship to MCU interface signals, please refer to the Timing Characteristics Diagrams. When 3-wire serial mode is selected, this pin must be connected to VSS.</p>															
15	E/RD#	I	<p>Read/Write Enable or Read This pin is MCU interface input. When interfacing to a 68XX-series microprocessor, this pin will be used as the Enable (E) signal. Read/write operation is initiated when this pin is pulled high and the CS# is pulled low. When connecting to an 80XX-microprocessor, this pin receives the Read (RD#) signal. Data read operation is initiated when this pin is pulled low and CS# is pulled low. When serial mode is selected, this pin must be connected to VSS.</p>															
16	R/W#	I	<p>Read/Write Select or Write This pin is MCU interface input. When interfacing to a 68XX-series microprocessor, this pin will be used as Read/Write (R/W#) selection input. Pull this pin to "High" for read mode and pull it to "Low" for write mode. When 80XX interface mode is selected, this pin will be the Write (WR#) input. Data write operation is initiated when this pin is pulled low and the CS# is pulled low. When serial mode is selected, this pin must be connected to VSS.</p>															
7~14	D7~D0	I/O	<p>Host Data Input/Output Bus These pins are 8-bit bi-directional data bus to be connected to the microprocessor's data bus. When serial mode is selected, D1 will be the serial data input SDIN and D0 will be the serial clock input SCLK. Unused pins must be connected to VSS except for D2.</p>															

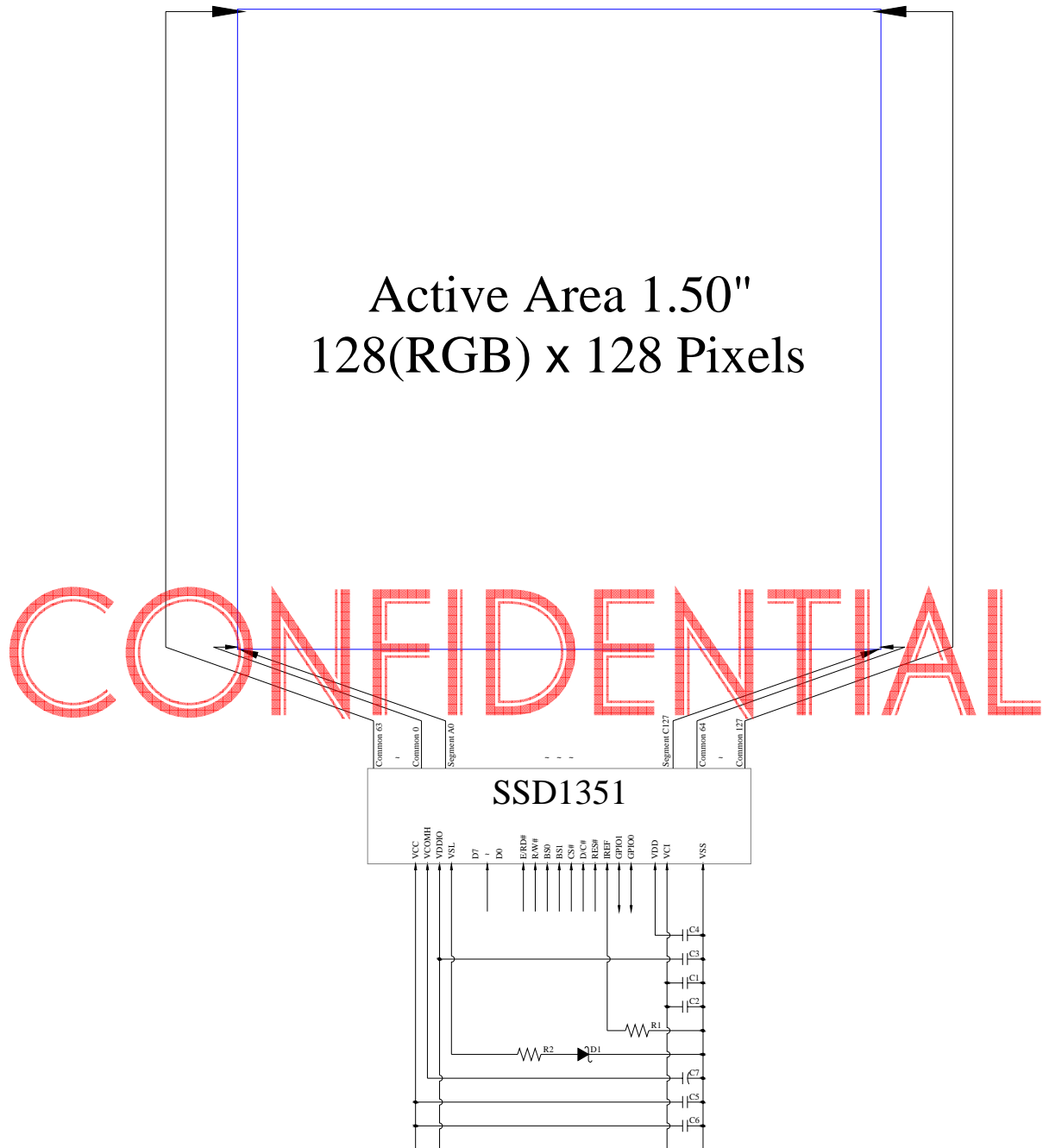
CONFIDENTIAL

1.5 Pin Definition (Continued)

Pin Number	Symbol	I/O	Function
<i>Reserve</i>			
6, 25, 29	N.C.	-	<i>Reserved Pin</i> The N.C. pins between function pins are reserved for compatible and flexible design.
1, 30	N.C. (GND)	-	<i>Reserved Pin (Supporting Pin)</i> The supporting pins can reduce the influences from stresses on the function pins. These pins must be connected to external ground.

CONFIDENTIAL

1.6 Block Diagram



MCU Interface Selection: BS0 and BS1
 Pins connected to MCU interface: D7~D0, E/RD#, R/W#, CS#, D/C#, and RES#

- C1, C5: 0.1µF
- C2: 4.7µF
- C6: 10µF
- C3, C4: 1µF
- C7: 4.7uF / 25V Tantalum Capacitor
- R1: 560kΩ, $R1 = (\text{Voltage at IREF} - VSS) / IREF$
- R2: 50Ω, 1/4W
- D1: ≤1.4V, 0.5W

2. Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit	Notes
Supply Voltage for Operation	V _{CI}	-0.3	4	V	1, 2
Supply Voltage for Logic	V _{DD}	-0.5	2.75	V	1, 2
Supply Voltage for I/O Pins	V _{DDIO}	-0.5	V _{CI}	V	1, 2
Supply Voltage for Display	V _{CC}	-0.5	16	V	1, 2
Operating Temperature	T _{OP}	-30	70	°C	-
Storage Temperature	T _{STG}	-40	80	°C	-

Note 1: All the above voltages are on the basis of “VSS = 0V”.

Note 2: When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to Section 3. “Optics & Electrical Characteristics”. If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate.

CONFIDENTIAL

3. Optics & Electrical Characteristics

3.1 Optics Characteristics

Characteristics	Symbol	Conditions	Min	Typ	Max	Unit
Brightness (White)	L_{br}	With Polarizer (Note 3)	70	90	-	cd/m ²
C.I.E. (White)	(x)	With Polarizer	0.26	0.30	0.34	
	(y)		0.29	0.33	0.37	
C.I.E. (Red)	(x)	With Polarizer	0.60	0.64	0.68	
	(y)		0.30	0.34	0.38	
C.I.E. (Green)	(x)	With Polarizer	0.27	0.31	0.35	
	(y)		0.58	0.62	0.66	
C.I.E. (Blue)	(x)	With Polarizer	0.10	0.14	0.18	
	(y)		0.12	0.16	0.20	
Dark Room Contrast	CR		-	>2000:1	-	
View Angle			>160	-	-	degree

* Optical measurement taken at $V_{CI} = 2.8V$, $V_{CC} = 13V$.

Software configuration follows Section 4.4 Initialization.

3.2 DC Characteristics

Characteristics	Symbol	Conditions	Min	Typ	Max	Unit
Supply Voltage for Operation	V_{CI}		2.4	2.8	3.5	V
Supply Voltage for Logic	V_{DD}		2.4	2.5	2.6	V
Supply Voltage for I/O Pins	V_{DDIO}		1.65	1.8	V_{CI}	V
Supply Voltage for Display	V_{CC}	Note 3	12.5	13	13.5	V
High Level Input	V_{IH}		$0.8 \times V_{DDIO}$	-	V_{DDIO}	V
Low Level Input	V_{IL}		0	-	$0.2 \times V_{DDIO}$	V
High Level Output	V_{OH}	$I_{out} = 100\mu A, 3.3MHz$	$0.9 \times V_{DDIO}$	-	V_{DDIO}	V
Low Level Output	V_{OL}	$I_{out} = 100\mu A, 3.3MHz$	0	-	$0.1 \times V_{DDIO}$	V
Operating Current for V_{CI}	I_{CI}		-	240	300	μA
Operating Current for V_{CC}	I_{CC}	Note 4	-	23.2	29.0	mA
		Note 5	-	33.4	41.8	mA
Sleep Mode Current for V_{CI}	$I_{CI, SLEEP}$		-	1	5	μA
Sleep Mode Current for V_{CC}	$I_{CC, SLEEP}$		-	1	5	μA

Note 3: Brightness (L_{br}) and Supply Voltage for Display (V_{CC}) are subject to the change of the panel characteristics and the customer's request.

Note 4: $V_{CI} = 2.8V$, $V_{CC} = 13V$, 50% Display Area Turn on.

Note 5: $V_{CI} = 2.8V$, $V_{CC} = 13V$, 100% Display Area Turn on.

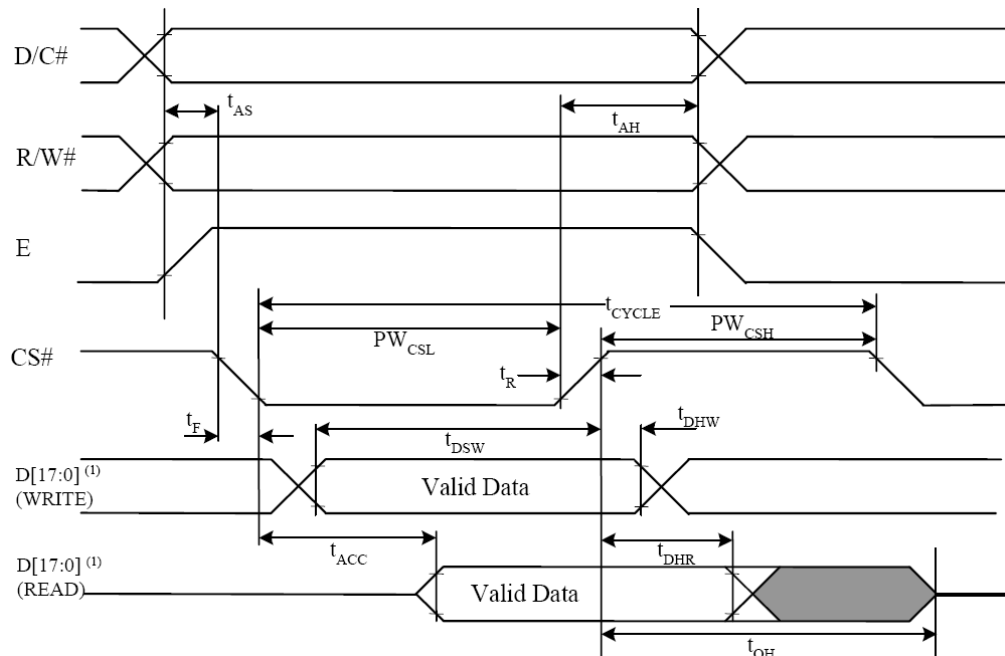
* Software configuration follows Section 4.4 Initialization.

3.3 AC Characteristics

3.3.1 68XX-Series MPU Parallel Interface Timing Characteristics:

Symbol	Description	Min	Max	Unit
t_{cycle}	Clock Cycle Time	300	-	ns
t_{AS}	Address Setup Time	10	-	ns
t_{AH}	Address Hold Time	0	-	ns
t_{DSW}	Write Data Setup Time	40	-	ns
t_{DHW}	Write Data Hold Time	7	-	ns
t_{DHR}	Read Data Hold Time	20	-	ns
t_{OH}	Output Disable Time	-	70	ns
t_{ACC}	Access Time	-	140	ns
PW_{CSL}	Chip Select Low Pulse Width (Read)	120	-	ns
	Chip Select Low Pulse Width (Write)	60	-	ns
PW_{CSH}	Chip Select High Pulse Width (Read)	60	-	ns
	Chip Select High Pulse Width (Write)	60	-	ns
t_{R}	Rise Time	-	15	ns
t_{F}	Fall Time	-	15	ns

*($V_{\text{DD}} - V_{\text{SS}} = 2.4\text{V}$ to 2.6V , $V_{\text{DDIO}} = 1.65\text{V}$, $V_{\text{CI}} = 2.8\text{V}$, $T_{\text{a}} = 25^{\circ}\text{C}$)

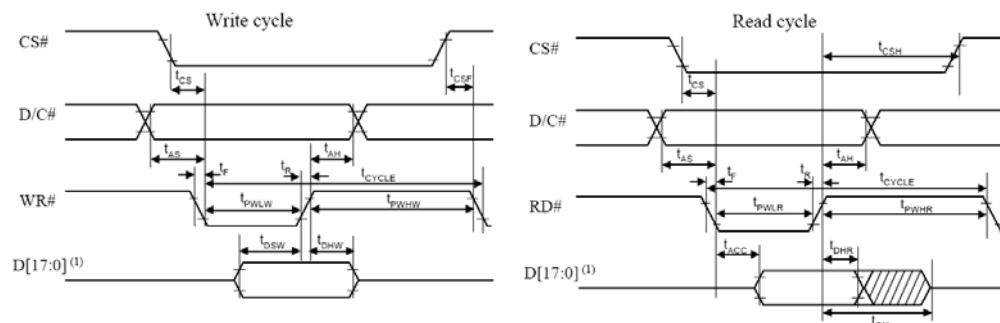


* (1) When 8-bit Used: D[7:0] Instead

3.3.2 80XX-Series MPU Parallel Interface Timing Characteristics:

Symbol	Description	Min	Max	Unit
t_{cycle}	Clock Cycle Time	300	-	ns
t_{AS}	Address Setup Time	10	-	ns
t_{AH}	Address Hold Time	0	-	ns
t_{DSW}	Write Data Setup Time	40	-	ns
t_{DHW}	Write Data Hold Time	7	-	ns
t_{DHR}	Read Data Hold Time	20	-	ns
t_{OH}	Output Disable Time	-	70	ns
t_{ACC}	Access Time	-	140	ns
t_{PWLR}	Read Low Time	150	-	ns
t_{PWLW}	Write Low Time	60	-	ns
t_{PWHR}	Read High Time	60	-	ns
t_{PWHW}	Write High Time	60	-	ns
t_{CS}	Chip Select Setup Time	0	-	ns
t_{CSH}	Chip Select Hold Time to Read Signal	0	-	ns
t_{CSF}	Chip Select Hold Time	20	-	ns
t_R	Rise Time	-	15	ns
t_F	Fall Time	-	15	ns

* ($V_{DD} - V_{SS} = 2.4V$ to $2.6V$, $V_{DDIO} = 1.65V$, $V_{CI} = 2.8V$, $T_a = 25^\circ C$)

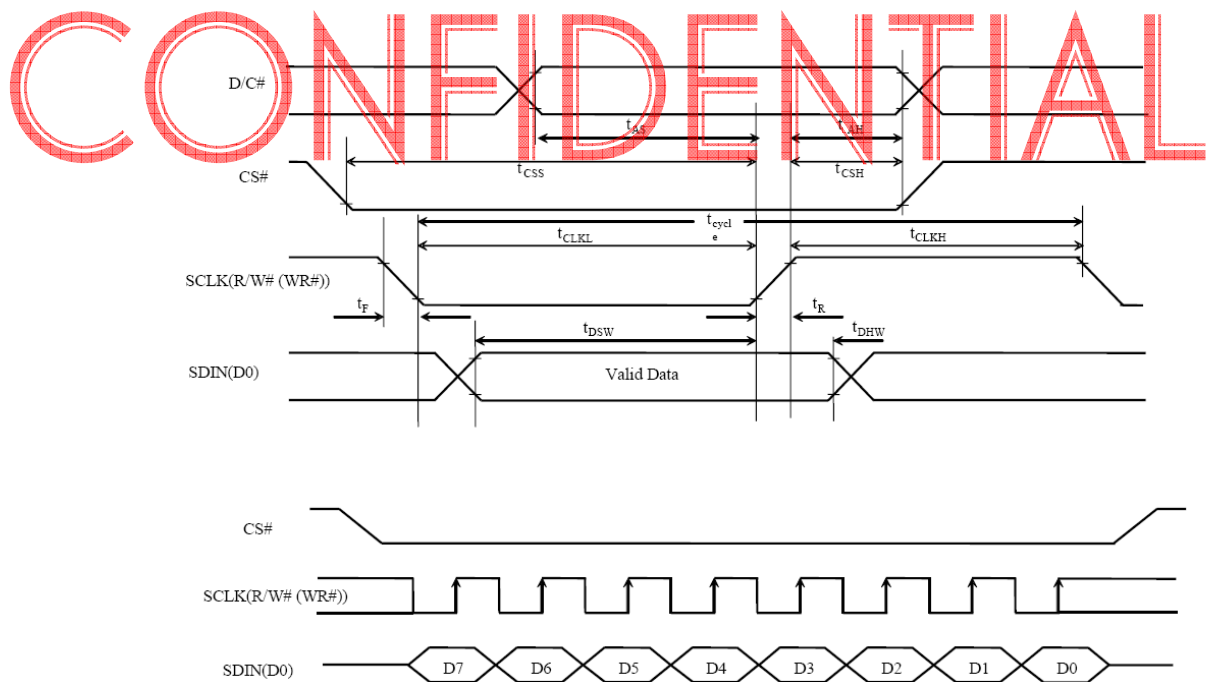


* (1) When 8-bit Used: D[7:0] Instead

3.3.3 Serial Interface Timing Characteristics: (4-wire SPI)

Symbol	Description	Min	Max	Unit
t_{cycle}	Clock Cycle Time	50	-	ns
t_{AS}	Address Setup Time	15	-	ns
t_{AH}	Address Hold Time	15	-	ns
t_{CSS}	Chip Select Setup Time	20	-	ns
t_{CSH}	Chip Select Hold Time	10	-	ns
t_{DSW}	Write Data Setup Time	15	-	ns
t_{DHW}	Write Data Hold Time	15	-	ns
t_{CLKL}	Clock Low Time	20	-	ns
t_{CLKH}	Clock High Time	20	-	ns
t_{R}	Rise Time	-	15	ns
t_{F}	Fall Time	-	15	ns

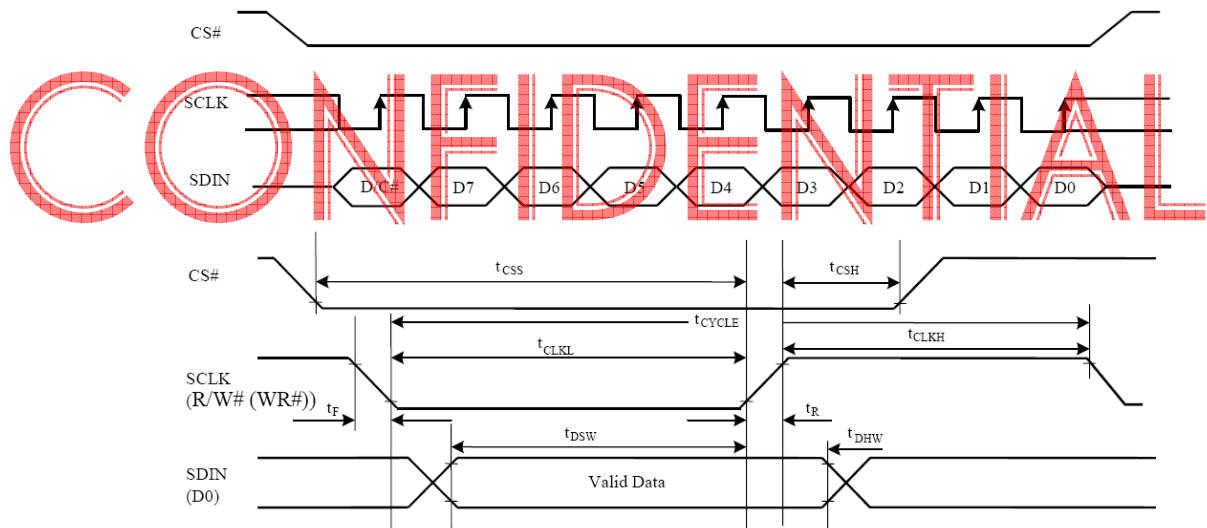
* ($V_{\text{DD}} - V_{\text{SS}} = 2.4\text{V to } 2.6\text{V}$, $V_{\text{DDIO}} = 1.65\text{V}$, $V_{\text{CI}} = 2.8\text{V}$, $T_{\text{a}} = 25^{\circ}\text{C}$)



3.3.4 Serial Interface Timing Characteristics: (3-wire SPI)

Symbol	Description	Min	Max	Unit
t_{cycle}	Clock Cycle Time	50	-	ns
t_{CSS}	Chip Select Setup Time	20	-	ns
t_{CSH}	Chip Select Hold Time	10	-	ns
t_{DSW}	Write Data Setup Time	15	-	ns
t_{DHW}	Write Data Hold Time	15	-	ns
t_{CLKL}	Clock Low Time	20	-	ns
t_{CLKH}	Clock High Time	20	-	ns
t_{R}	Rise Time	-	15	ns
t_{F}	Fall Time	-	15	ns

* ($V_{\text{DD}} - V_{\text{SS}} = 2.4\text{V to } 2.6\text{V}$, $V_{\text{DDIO}} = 1.65\text{V}$, $V_{\text{CI}} = 2.8\text{V}$, $T_{\text{a}} = 25^{\circ}\text{C}$)



4. Functional Specification

4.1. Commands

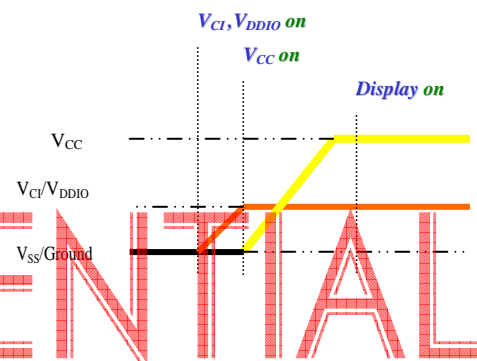
Refer to the Technical Manual for the SSD1351

4.2 Power down and Power up Sequence

To protect OEL panel and extend the panel life time, the driver IC power up/down routine should include a delay period between high voltage and low voltage power sources during turn on/off. It gives the OEL panel enough time to complete the action of charge and discharge before/after the operation.

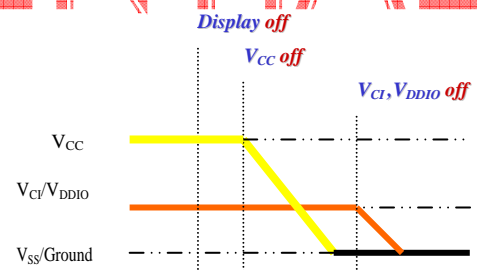
4.2.1 Power up Sequence:

1. Power up V_{CI} & V_{DDIO}
2. Send Display off command
3. Initialization
4. Clear Screen
5. Power up V_{CC}
6. Delay 100ms
(when V_{CC} is stable)
7. Send Display on command



4.2.2 Power down Sequence:

1. Send Display off command
2. Power down V_{CC}
3. Delay 100ms
(when V_{CC} is reach 0 and panel is completely discharges)
4. Power down V_{CI} & V_{DDIO}



4.3 Reset Circuit

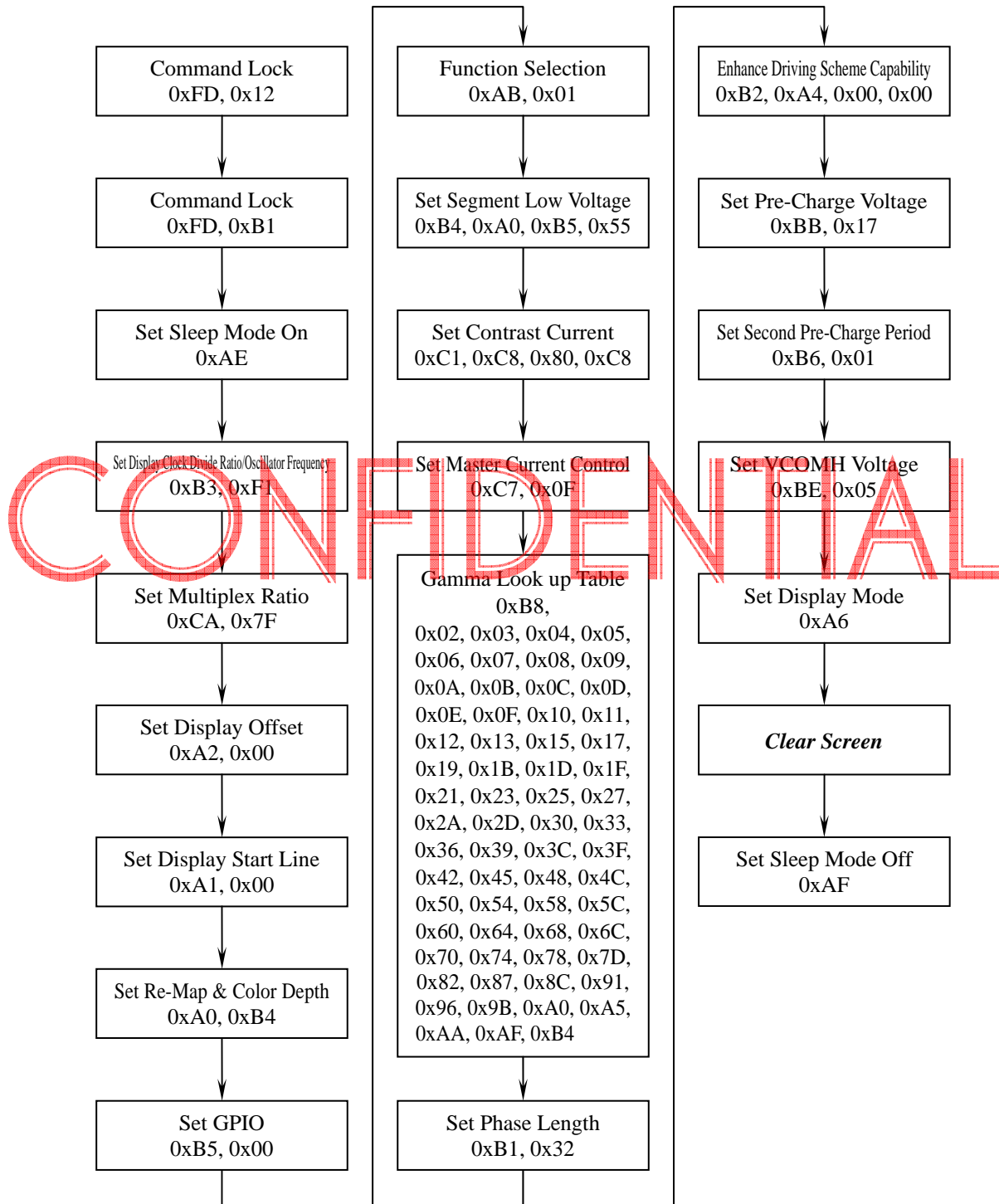
When RES# input is low, the chip is initialized with the following status:

1. Display is OFF
2. 128(RGB)×128 Display Mode
3. Normal segment and display data column and row address mapping (SEG0 mapped to column address 00h and COM0 mapped to row address 00h)
4. Display start line is set at display RAM address 0
5. Column address counter is set at 0
6. Normal scan direction of the COM outputs
7. Command A2h, B1h, B3h, BBh, BEh are locked by command FDh

4.4 Actual Application Example

Command usage and explanation of an actual example

<Initialization>



If the noise is accidentally occurred at the displaying window during the operation, please reset the display in order to recover the display function.

5. Reliability

5.1 Contents of Reliability Tests

Item	Conditions	Criteria
High Temperature Operation	70°C, 240 hrs	The operational functions work.
Low Temperature Operation	-30°C, 240 hrs	
High Temperature Storage	80°C, 240 hrs	
Low Temperature Storage	-40°C, 240 hrs	
High Temperature/Humidity Operation	60°C, 90% RH, 120 hrs	
Thermal Shock	-40°C ⇔ 85°C, 24 cycles 60 mins dwell	

- * The samples used for the above tests do not include polarizer.
- * No moisture condensation is observed during tests.

5.2 Lifetime

End of lifetime is specified as 50% of initial brightness.

Parameter	Min	Max	Unit	Condition	Notes
Operating Life Time	10,000	-	hr	90 cd/m ² , 50% Checkerboard	6
Storage Life Time	20,000	-	hr	T _a = 25°C, 50% RH	-

Note 6: The average operating lifetime at room temperature is estimated by the accelerated operation at high temperature conditions.

5.3 Failure Check Standard

After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure test at 23±5°C; 55±15% RH.

6. Outgoing Quality Control Specifications

6.1 Environment Required

Customer's test & measurement are required to be conducted under the following conditions:

Temperature:	23 ± 5°C
Humidity:	55 ± 15 %RH
Fluorescent Lamp:	30W
Distance between the Panel & Lamp:	≥ 50 cm
Distance between the Panel & Eyes of the Inspector:	≥ 30 cm
Finger glove (or finger cover) must be worn by the inspector.	
Inspection table or jig must be anti-electrostatic.	

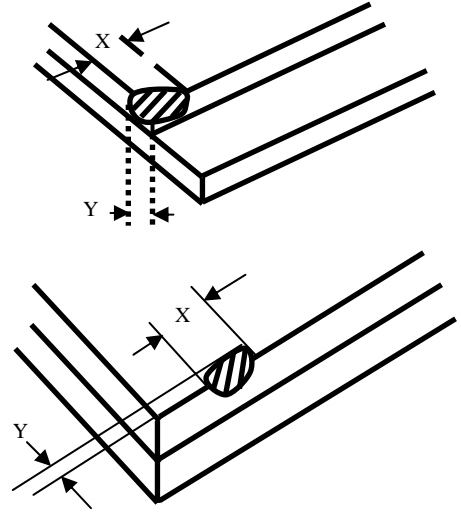
6.2 Sampling Plan

Level II, Normal Inspection, Single Sampling, MIL-STD-105E

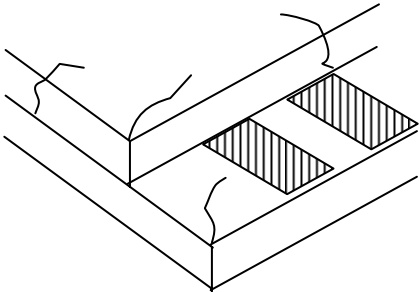

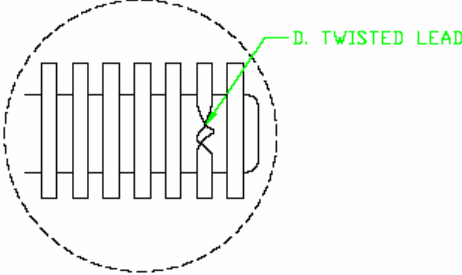
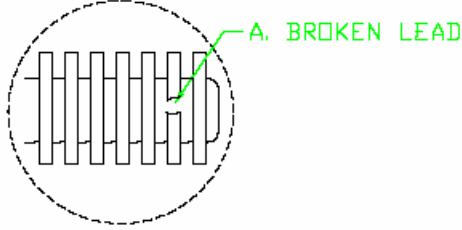
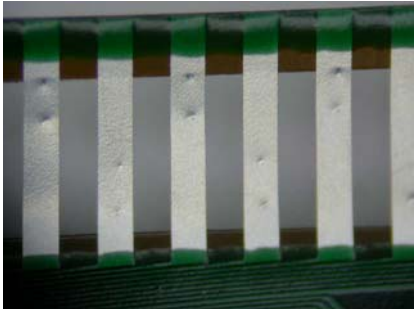
6.3 Criteria & Acceptable Quality Level

Partition	AQL	Definition
Major	0.65	Defects in Pattern Check (Display On)
Minor	1.0	Defects in Cosmetic Check (Display Off)

6.3.1 Cosmetic Check (Display Off) in Non-Active Area

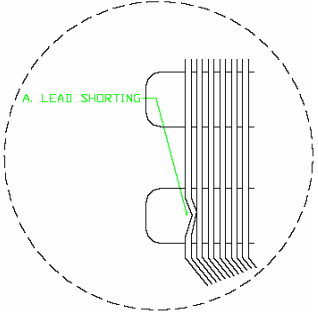
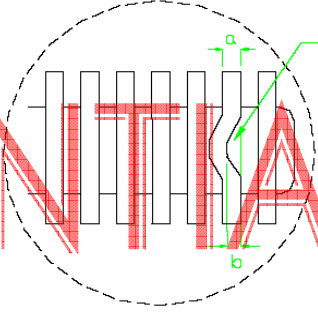
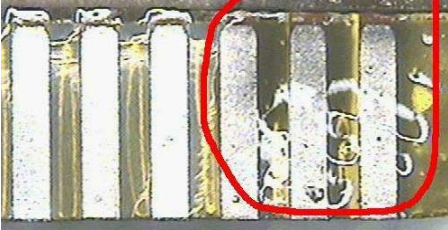
Check Item	Classification	Criteria
Panel General Chipping	Minor	<p>X > 6 mm (Along with Edge) Y > 1 mm (Perpendicular to edge)</p> 

6.3.1 Cosmetic Check (Display Off) in Non-Active Area (Continued)

Check Item	Classification	Criteria
Panel Crack	Minor	<p>Any crack is not allowable.</p> 
Copper Exposed (Even Pin or Film)	Minor	<p>Not Allowable by Naked Eye Inspection</p>
Film or Trace Damage	Minor	 <p>Not Allowable</p>
Terminal Lead Twist	Minor	
Terminal Lead Broken	Minor	<p>Not Allowable</p> 
Terminal Lead Prober Mark	Acceptable	

CONFIDENTIAL

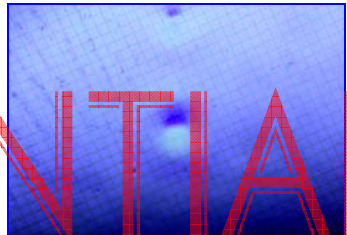
6.3.1 Cosmetic Check (Display Off) in Non-Active Area (Continued)

Check Item	Classification	Criteria
Terminal Lead Bent (Not Twist or Broken)	Minor	<p>NG if any bent lead cause lead shorting.</p> 
	Minor	<p>NG for horizontally bent lead more than 50% of its width.</p> 
Glue or Contamination on Pin (Couldn't Be Removed by Alcohol)	Minor	
Ink Marking on Back Side of panel (Exclude on Film)	Acceptable	Ignore for Any

CONFIDENTIAL

6.3.2 Cosmetic Check (Display Off) in Active Area

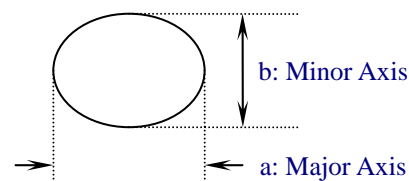
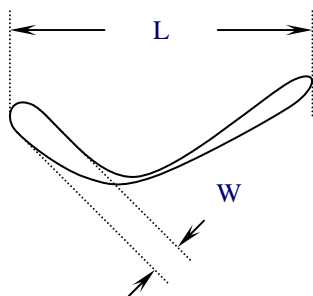
It is recommended to execute in clear room environment (class 10k) if actual in necessary.

Check Item	Classification	Criteria
Any Dirt & Scratch on Protective Film	Acceptable	Ignore for Any
Scratches, Fiber, Line-Shape Defect (On Polarizer)	Minor	$W \leq 0.1$ Ignore $W > 0.1, L \leq 2$ $n \leq 1$ $L > 2$ $n = 0$
Dirt, Spot-Shape Defect (On Polarizer)	Minor	$\Phi \leq 0.1$ Ignore $0.1 < \Phi \leq 0.25$ $n \leq 1$ $0.25 < \Phi$ $n = 0$
Dent, Bubbles, White spot (Any Transparent Spot on Polarizer)	Minor	$\Phi \leq 0.5$ → Ignore if no Influence on Display $0.5 < \Phi$ $n = 0$ 
Fingerprint, Flow Mark (On Polarizer)	Minor	Not allowable

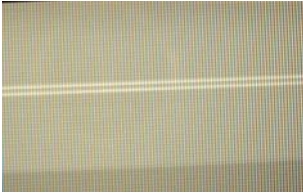
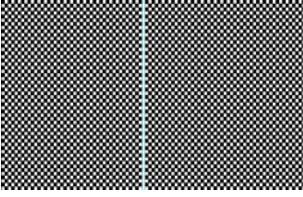
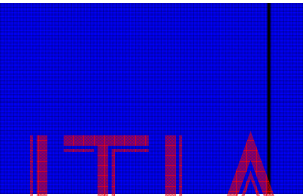
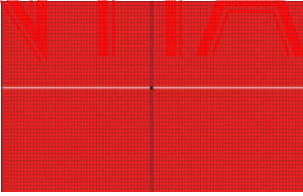
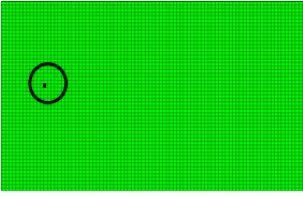
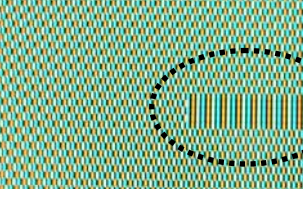
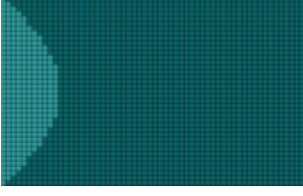
CONFIDENTIAL

* Protective film should not be tear off when cosmetic check.

** Definition of W & L & Φ (Unit: mm): $\Phi = (a + b) / 2$

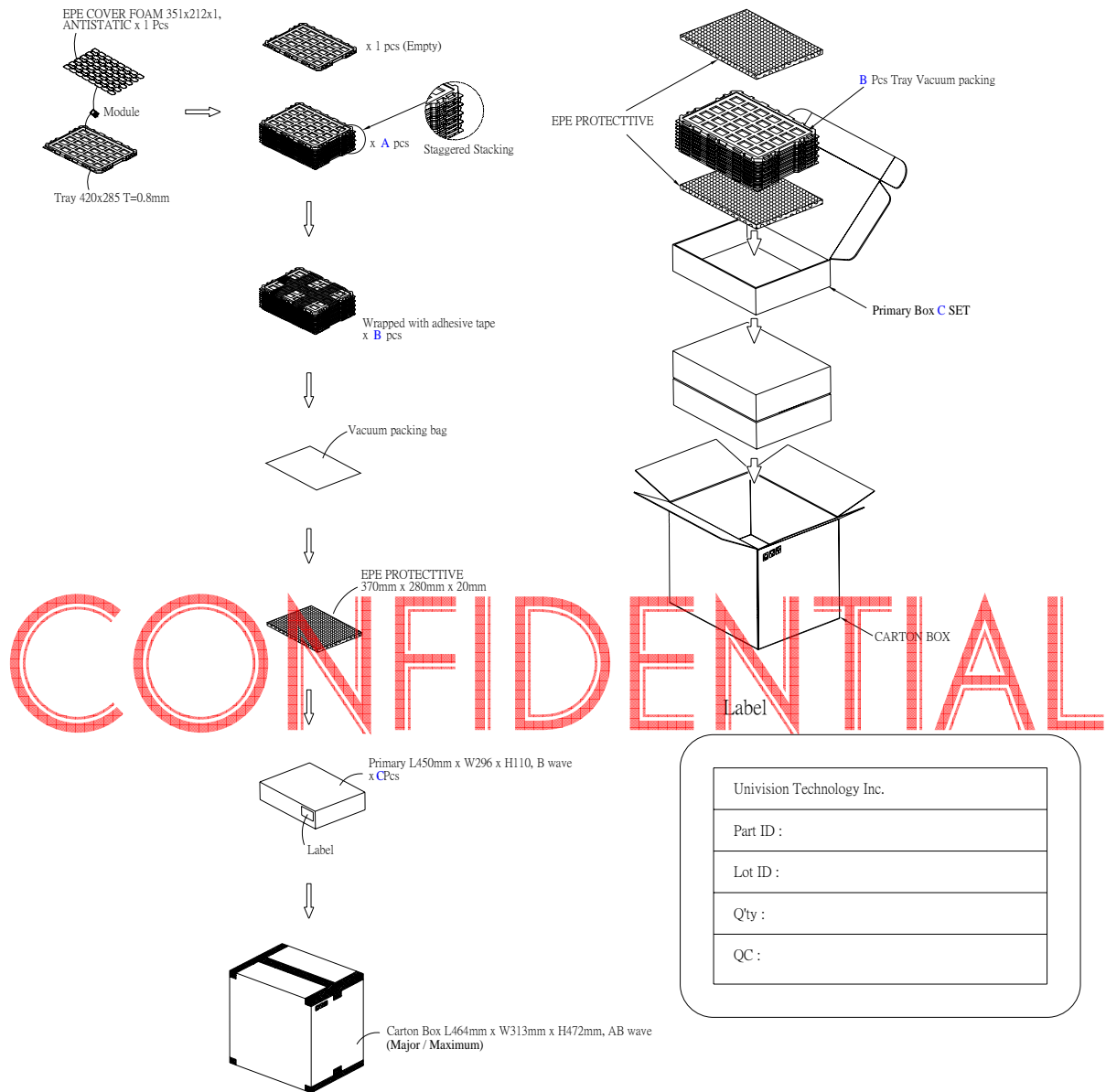


6.3.3 Pattern Check (Display On) in Active Area

Check Item	Classification	Criteria
No Display	Major	Not allowable
Bright Line	Major	
Missed Line	Major	 
Pixel Short	Major	
Darker Pixel	Major	
Wrong Display	Major	
Un-Uniform (Luminance Variation within a Display)	Major	

CONFIDENTIAL

7. Package Specifications



Item	Quantity
Holding Trays (A)	15 per Primary Box
Total Trays (B)	16 per Primary Box (Including 1 Empty Tray)
Primary Box (C)	1~4 per Carton (4 as Major / Maximum)

8. Precautions When Using These OEL Display Modules

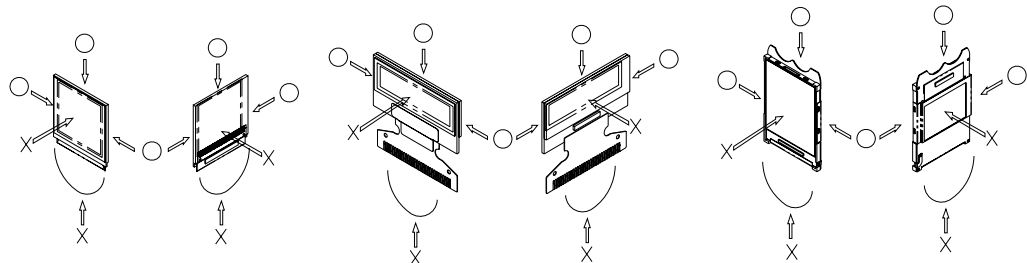
8.1 Handling Precautions

- 1) Since the display panel is being made of glass, do not apply mechanical impacts such as dropping from a high position.
- 2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- 3) If pressure is applied to the display surface or its neighborhood of the OEL display module, the cell structure may be damaged and be careful not to apply pressure to these sections.
- 4) The polarizer covering the surface of the OEL display module is soft and easily scratched. Please be careful when handling the OEL display module.
- 5) When the surface of the polarizer of the OEL display module has soil, clean the surface. It takes advantage of by using following adhesion tape.
 - * Scotch Mending Tape No. 810 or an equivalent
 Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy.

Also, pay attention that the following liquid and solvent may spoil the polarizer:

- * Water
- * Ketone
- * Aromatic Solvents

- 6) Hold OEL display module very carefully when placing OEL display module into the system housing. Do not apply excessive stress or pressure to OEL display module. And, do not over bend the film with electrode pattern layouts. These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases.



- 7) Do not apply stress to the LSI chips and the surrounding molded sections.
- 8) Do not disassemble nor modify the OEL display module.
- 9) Do not apply input signals while the logic power is off.
- 10) Pay sufficient attention to the working environments when handing OEL display modules to prevent occurrence of element breakage accidents by static electricity.
 - * Be sure to make human body grounding when handling OEL display modules.
 - * Be sure to ground tools to use or assembly such as soldering irons.
 - * To suppress generation of static electricity, avoid carrying out assembly work under dry environments.
 - * Protective film is being applied to the surface of the display panel of the OEL display module. Be careful since static electricity may be generated when exfoliating the protective film.
- 11) Protection film is being applied to the surface of the display panel and removes

the protection film before assembling it. At this time, if the OEL display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5).

- 12) If electric current is applied when the OEL display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful to avoid the above.

8.2 Storage Precautions

- 1) When storing OEL display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps, etc. and, also, avoiding high temperature and high humidity environments or low temperature (less than 0°C) environments. (We recommend you to store these modules in the packaged state when they were shipped from Univision Technology Inc.)

At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them.

- 2) If electric current is applied when water drops are adhering to the surface of the OEL display module, when the OEL display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above.

8.3 Designing Precautions

- 1) The absolute maximum ratings are the ratings which cannot be exceeded for OEL display module, and if these values are exceeded, panel damage may be happen.
- 2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specifications and, at the same time, to make the signal line cable as short as possible.
- 3) We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VCI). (Recommend value: 0.5A)
- 4) Pay sufficient attention to avoid occurrence of mutual noise interference with the neighboring devices.
- 5) As for EMI, take necessary measures on the equipment side basically.
- 6) When fastening the OEL display module, fasten the external plastic housing section.
- 7) If power supply to the OEL display module is forcibly shut down by such errors as taking out the main battery while the OEL display panel is in operation, we cannot guarantee the quality of this OEL display module.
- 8) The electric potential to be connected to the rear face of the IC chip should be as follows: SSD1351
* Connection (contact) to any other potential than the above may lead to rupture of the IC.

8.4 Precautions when disposing of the OEL display modules

- 1) Request the qualified companies to handle industrial wastes when disposing of the OEL display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.

8.5 Other Precautions

- 1) When an OEL display module is operated for a long of time with fixed pattern may remain as an after image or slight contrast deviation may occur. Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored. Also, there will be no problem in the reliability of the module.
- 2) To protect OEL display modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the OEL display modules.
 - * Pins and electrodes
 - * Pattern layouts such as the COF
- 3) With this OEL display module, the OEL driver is being exposed. Generally speaking, semiconductor elements change their characteristics when light is radiated according to the principle of the solar battery. Consequently, if this OEL driver is exposed to light, malfunctioning may occur.
 - * Design the product and installation method so that the OEL driver may be shielded from light in actual usage.
 - * Design the product and installation method so that the OEL driver may be shielded from light during the inspection processes.
- 4) Although this OEL display module stores the operation state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal status may be changed. It therefore is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design.
- 5) We recommend you to construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.

CONFIDENTIAL

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[Embedded Artists:](#)

[EA-LCD-008](#)